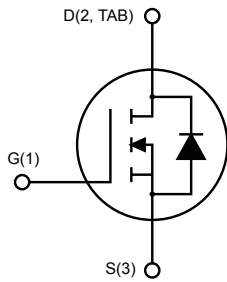
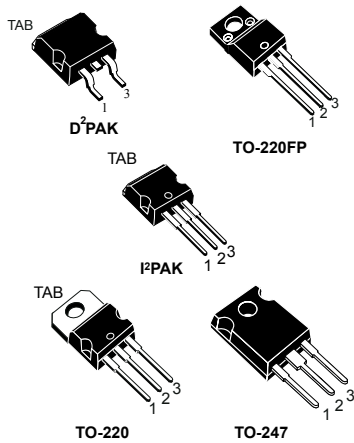


N-channel 650 V, 70 mΩ typ., 33 A, MDmesh M5 Power MOSFETs in D<sup>2</sup>PAK, TO-220FP, I<sup>2</sup>PAK, TO-220 and TO-247 packages



AM01475v1\_noZen



## Features

Order codes	V <sub>DS</sub> @ T <sub>Jmax</sub>	R <sub>DS(on)</sub> max.	I <sub>D</sub>	Package
STB42N65M5	710 V	79 mΩ	33 A	D <sup>2</sup> PAK
STF42N65M5				TO-220FP
STI42N65M5				I <sup>2</sup> PAK
STP42N65M5				TO-220
STW42N65M5				TO-247

- Extremely low R<sub>DS(on)</sub>
- Low gate charge and input capacitance
- Excellent switching performance
- 100% avalanche tested

## Applications

- Switching applications

## Description

These devices are N-channel Power MOSFETs based on the MDmesh M5 innovative vertical process technology combined with the well-known PowerMESH horizontal layout. The resulting products offer extremely low on-resistance, making them particularly suitable for applications requiring high power and superior efficiency.

### Product status

STB42N65M5
STF42N65M5
STI42N65M5
STP42N65M5
STW42N65M5

# 1 Electrical ratings

**Table 1. Absolute maximum ratings**

Symbol	Parameter	Value		Unit
		D <sup>2</sup> PAK, I <sup>2</sup> PAK, TO-220, TO-247	TO-220FP	
V <sub>GS</sub>	Gate-source voltage	±25		V
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 25 °C	33	33 <sup>(1)</sup>	A
	Drain current (continuous) at T <sub>C</sub> = 100 °C	20.8	20.8 <sup>(1)</sup>	A
I <sub>DM</sub> <sup>(2)</sup>	Drain current (pulsed)	132	132	A
P <sub>TOT</sub>	Total power dissipation at T <sub>C</sub> = 25 °C	190	40	W
dv/dt <sup>(3)</sup>	Peak diode recovery voltage slope	15		V/ns
V <sub>ISO</sub>	Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1 s; T <sub>C</sub> = 25 °C)		2500	V
T <sub>J</sub>	Operating junction temperature range	-55 to 150		°C
T <sub>stg</sub>	Storage temperature range			

- Limited by maximum junction temperature.
- Pulse width limited by safe operating area.
- I<sub>SD</sub> ≤ 33 A, di/dt ≤ 400 A/μs, V<sub>DD</sub> = 400 V, V<sub>DS(peak)</sub> < V<sub>(BR)DSS</sub>.

**Table 2. Thermal data**

Symbol	Parameter	Value					Unit
		D <sup>2</sup> PAK	I <sup>2</sup> PAK	TO-220	TO-247	TO-220FP	
R <sub>thj-case</sub>	Thermal resistance junction-case	0.66				3.1	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-ambient		62.5		50	62.5	°C/W
R <sub>thj-pcb</sub> <sup>(1)</sup>	Thermal resistance junction-pcb	30					°C/W

- When mounted on an 1 inch<sup>2</sup> FR-4, 2 Oz copper board.

**Table 3. Avalanche characteristics**

Symbol	Parameter	Value	Unit
I <sub>AR</sub>	Avalanche current, repetitive or non-repetitive (pulse width limited by T <sub>Jmax</sub> )	11	A
E <sub>AS</sub>	Single pulse avalanche energy (starting T <sub>J</sub> = 25 °C, I <sub>D</sub> = I <sub>AR</sub> , V <sub>DD</sub> = 50 V)	950	mJ

## 2 Electrical characteristics

( $T_{CASE} = 25\text{ }^{\circ}\text{C}$  unless otherwise specified)

**Table 4. On/off states**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$I_D = 1\text{ mA}$ , $V_{GS} = 0\text{ V}$	650			V
$I_{DSS}$	Zero gate voltage drain current	$V_{GS} = 0\text{ V}$ , $V_{DS} = 650\text{ V}$			1	$\mu\text{A}$
		$V_{GS} = 0\text{ V}$ , $V_{DS} = 650\text{ V}$ , $T_C = 125\text{ }^{\circ}\text{C}$ <sup>(1)</sup>			100	$\mu\text{A}$
$I_{GSS}$	Gate body leakage current	$V_{GS} = \pm 25\text{ V}$ , $V_{DS} = 0\text{ V}$			100	nA
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}$ , $I_D = 250\text{ }\mu\text{A}$	3	4	5	V
$R_{DS(on)}$	Static drain-source on- resistance	$V_{GS} = 10\text{ V}$ , $I_D = 16.5\text{ A}$		70	79	m $\Omega$

1. Defined by design, not subject to production test.

**Table 5. Dynamic**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$C_{iss}$	Input capacitance	$V_{DS} = 100\text{ V}$ , $f = 1\text{ MHz}$ , $V_{GS} = 0\text{ V}$		4650		pF
$C_{oss}$	Output capacitance			110	-	
$C_{rss}$	Reverse transfer capacitance			3.2		
$C_{o(tr)}$ <sup>(1)</sup>	Equivalent capacitance time related	$V_{DS} = 0\text{ to }520\text{ V}$ , $V_{GS} = 0\text{ V}$		100	-	pF
$C_{o(er)}$ <sup>(2)</sup>	Equivalent capacitance energy related			285	-	
$R_g$	Gate input resistance	$f = 1\text{ MHz}$ , $I_D = 0\text{ A}$		1.1	-	$\Omega$
$Q_g$	Total gate charge	$V_{DD} = 520\text{ V}$ , $I_D = 33\text{ A}$ ,		98	-	nC
$Q_{gs}$	Gate-source charge	$V_{GS} = 0\text{ to }10\text{ V}$ (see Figure 20. Test circuit for gate charge behavior)		28	-	
$Q_{gd}$	Gate-drain charge			39	-	

1.  $C_{o(tr)}$  is a constant capacitance value that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 80%  $V_{DSS}$ .

2.  $C_{o(er)}$  is a constant capacitance value that gives the same stored energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 80%  $V_{DSS}$ .

**Table 6. Switching times**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(v)}$	Voltage delay time	$V_{DD} = 400\text{ V}$ , $I_D = 20\text{ A}$ , $R_G = 4.7\text{ }\Omega$ , $V_{GS} = 10\text{ V}$		52		ns
$t_{r(v)}$	Voltage rise time			8.4		
$t_{f(i)}$	Current fall time	(see Figure 21. Test circuit for inductive load switching and diode recovery times and Figure 24. Switching time waveform)		8.7	-	
$t_{c(off)}$	Crossing time			14		

**Table 7. Source-drain diode**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit	
$I_{SD}$	Source-drain current		-		33	A	
$I_{SDM}^{(1)}$	Source-drain current (pulsed)				132		
$V_{SD}^{(2)}$	Forward on voltage	$I_{SD} = 33\text{ A}$ , $V_{GS} = 0\text{ V}$	-		1.5	V	
$t_{rr}$	Reverse recovery time	$I_{SD} = 33\text{ A}$ , $di/dt = 100\text{ A}/\mu\text{s}$ $V_{DD} = 100\text{ V}$ (see Figure 21. Test circuit for inductive load switching and diode recovery times)	-	400		ns	
$Q_{rr}$	Reverse recovery charge			7			μC
$I_{RRM}$	Reverse recovery current			35			
$t_{rr}$	Reverse recovery time	$I_{SD} = 33\text{ A}$ , $di/dt = 100\text{ A}/\mu\text{s}$ $V_{DD} = 100\text{ V}$ , $T_j = 150\text{ °C}$ (see Figure 21. Test circuit for inductive load switching and diode recovery times)	-	532		ns	
$Q_{rr}$	Reverse recovery charge			10			μC
$I_{RRM}$	Reverse recovery current			38			

1. Pulse width limited by safe operating area.
2. Pulsed: pulse duration = 300 μs, duty cycle 1.5%.

## 2.1 Electrical characteristics (curves)

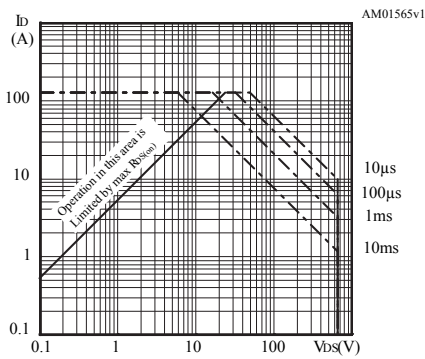
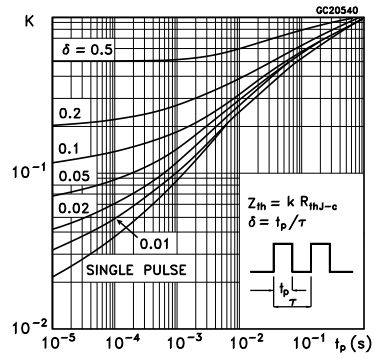
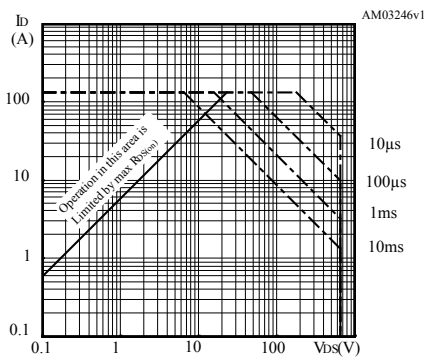
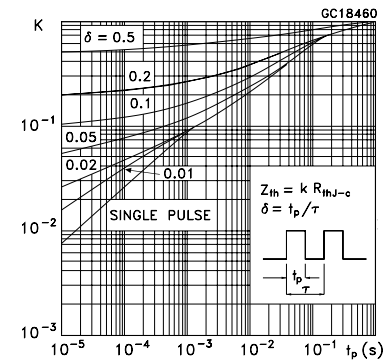
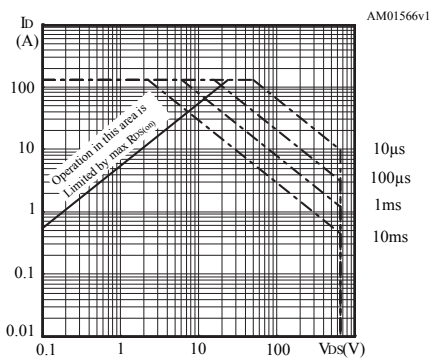
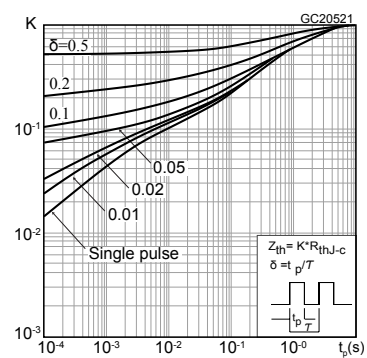
**Figure 1. Safe operating area for D<sup>2</sup>PAK, I<sup>2</sup>PAK, TO-220**

**Figure 2. Thermal impedance for D<sup>2</sup>PAK, I<sup>2</sup>PAK, TO-220**

**Figure 3. Safe operating area for TO-247**

**Figure 4. Thermal impedance for TO-247**

**Figure 5. Safe operating area for TO-220FP**

**Figure 6. Thermal impedance for TO-220FP**


Figure 7. Output characteristics

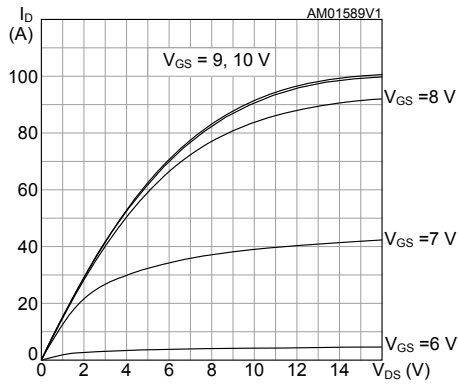


Figure 8. Transfer characteristics

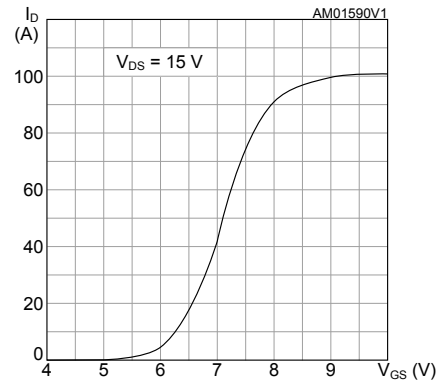


Figure 9. Gate charge vs gate-source voltage

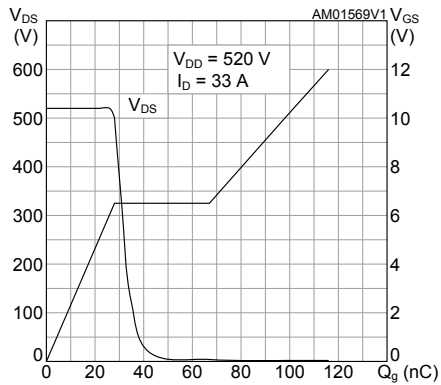


Figure 10. Static drain-source on-resistance

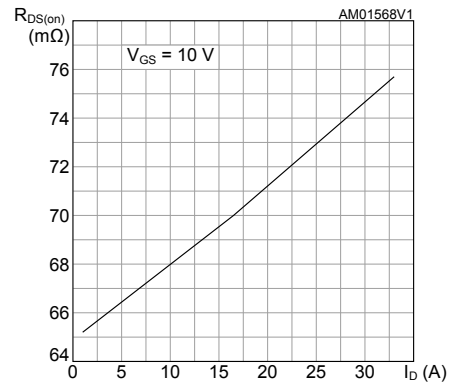


Figure 11. Capacitance variations

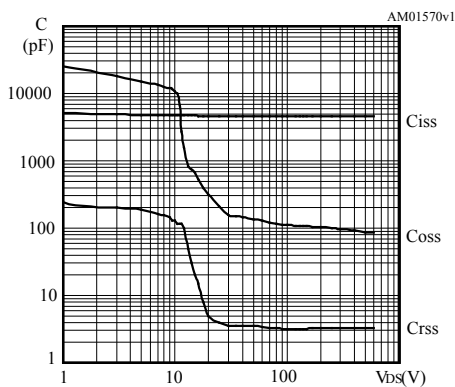
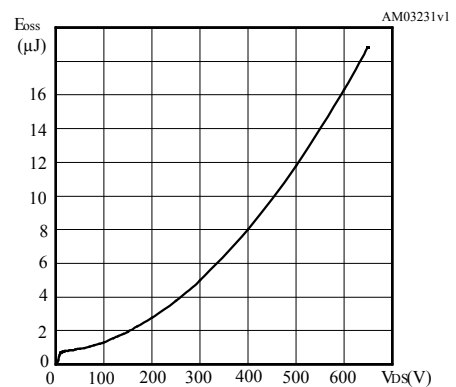
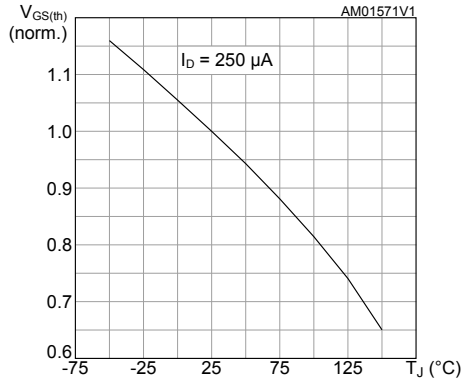
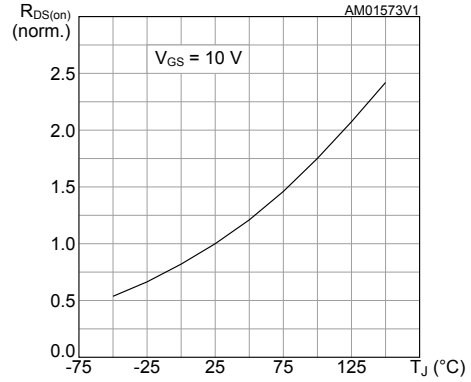
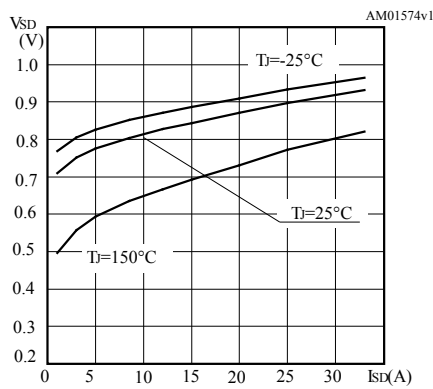
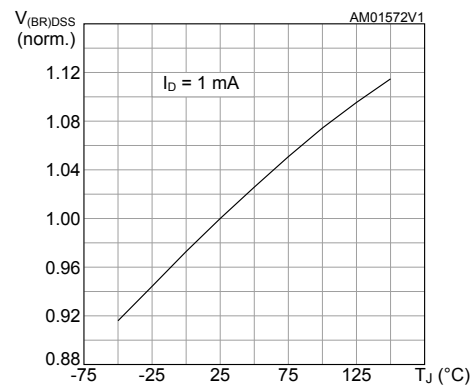
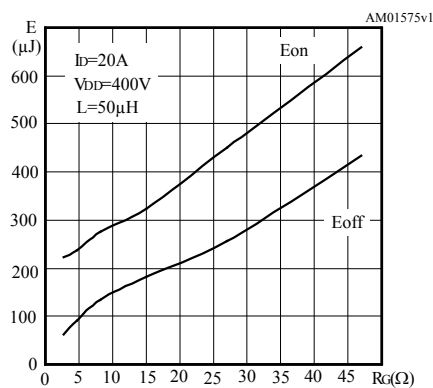


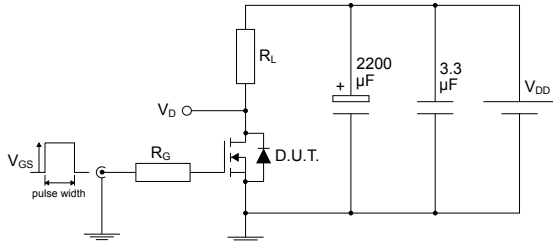
Figure 12. Output capacitance stored energy



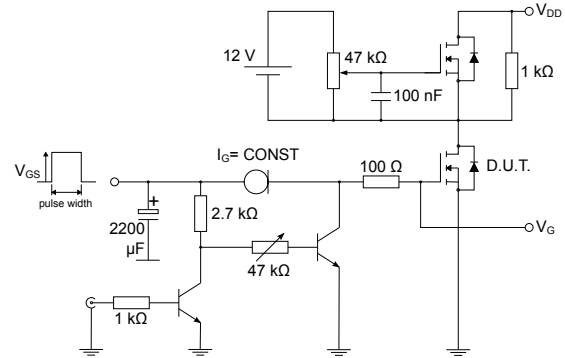
**Figure 13. Normalized gate threshold voltage vs temperature**

**Figure 14. Normalized on-resistance vs temperature**

**Figure 15. Source-drain diode forward characteristics**

**Figure 16. Normalized  $V_{(BR)DSS}$  vs temperature**

**Figure 17. Switching energy vs gate resistance**


Note:  $E_{on}$  including reverse recovery of a SiC diode.

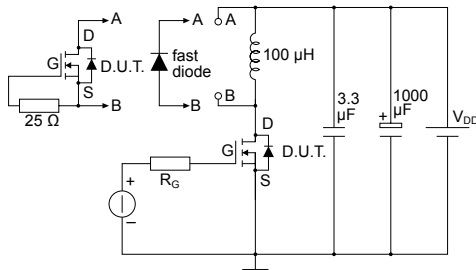
### 3 Test circuits

**Figure 19. Test circuit for resistive load switching times**


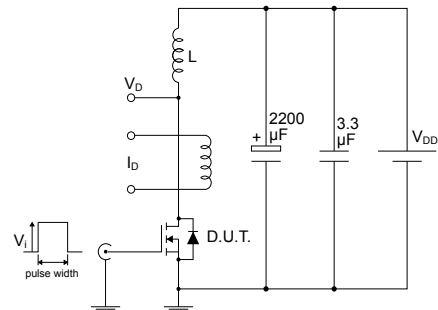
AM01468v1

**Figure 20. Test circuit for gate charge behavior**


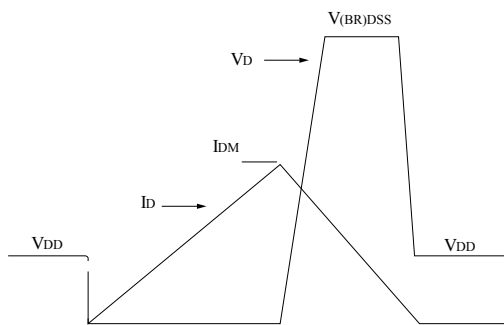
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**Figure 21. Test circuit for inductive load switching and diode recovery times**


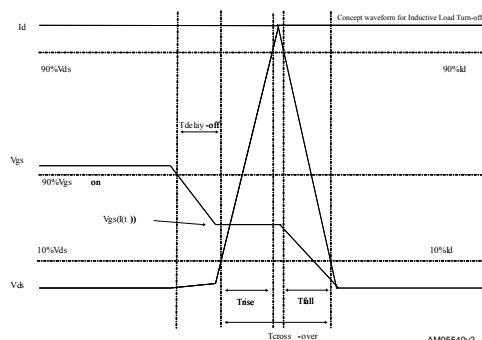
AM01470v1

**Figure 22. Unclamped inductive load test circuit**


AM01471v1

**Figure 23. Unclamped inductive waveform**


AM01472v1

**Figure 24. Switching time waveform**


AM05540v2





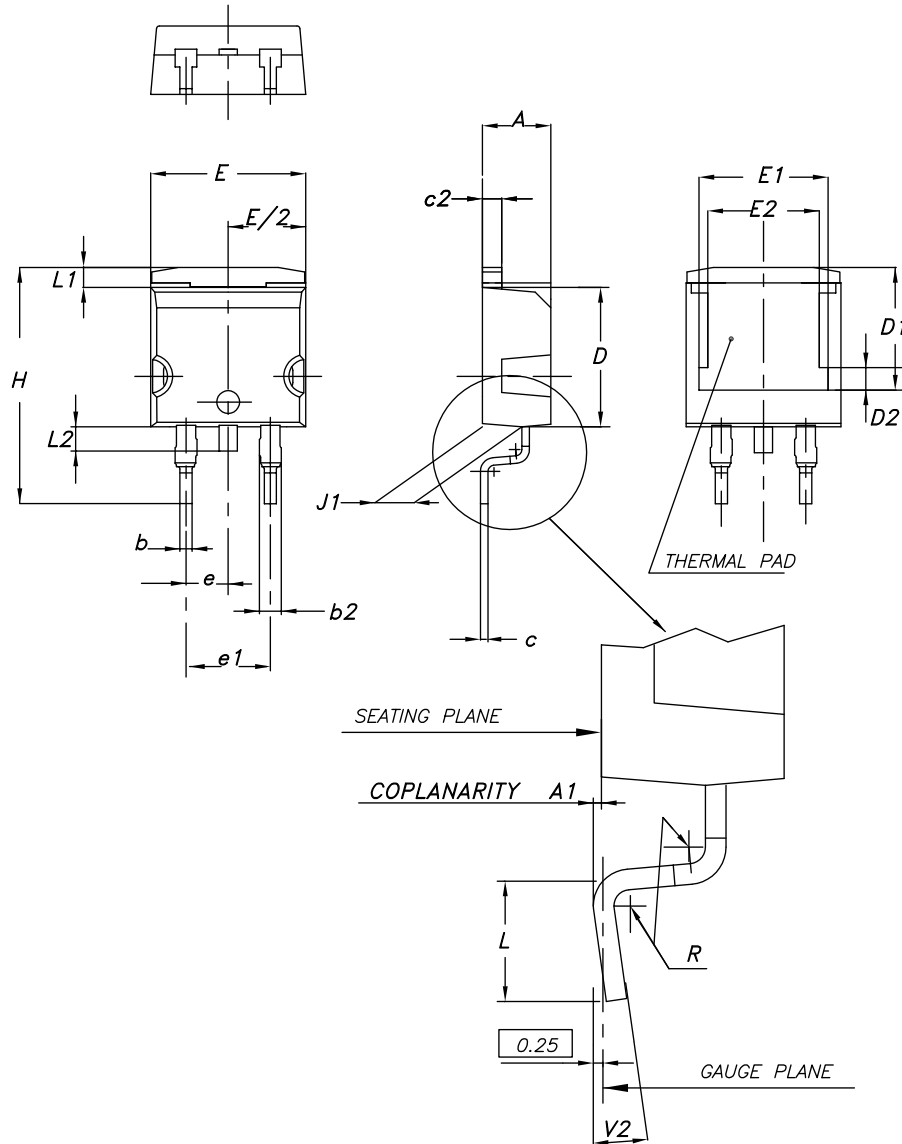
## 4 Package information

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In order to meet environmental requirements, ST offers these devices in different grades of **ECOPACK** packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

#### 4.1 D<sup>2</sup>PAK (TO-263) type A2 package information

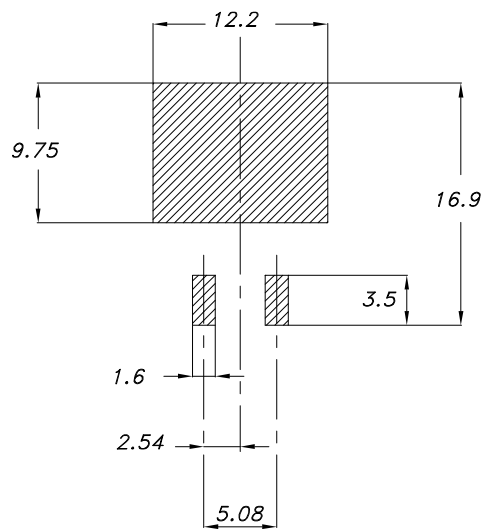
Figure 25. D<sup>2</sup>PAK (TO-263) type A2 package outline



0079457\_A2\_26

**Table 8. D<sup>2</sup>PAK (TO-263) type A2 package mechanical data**

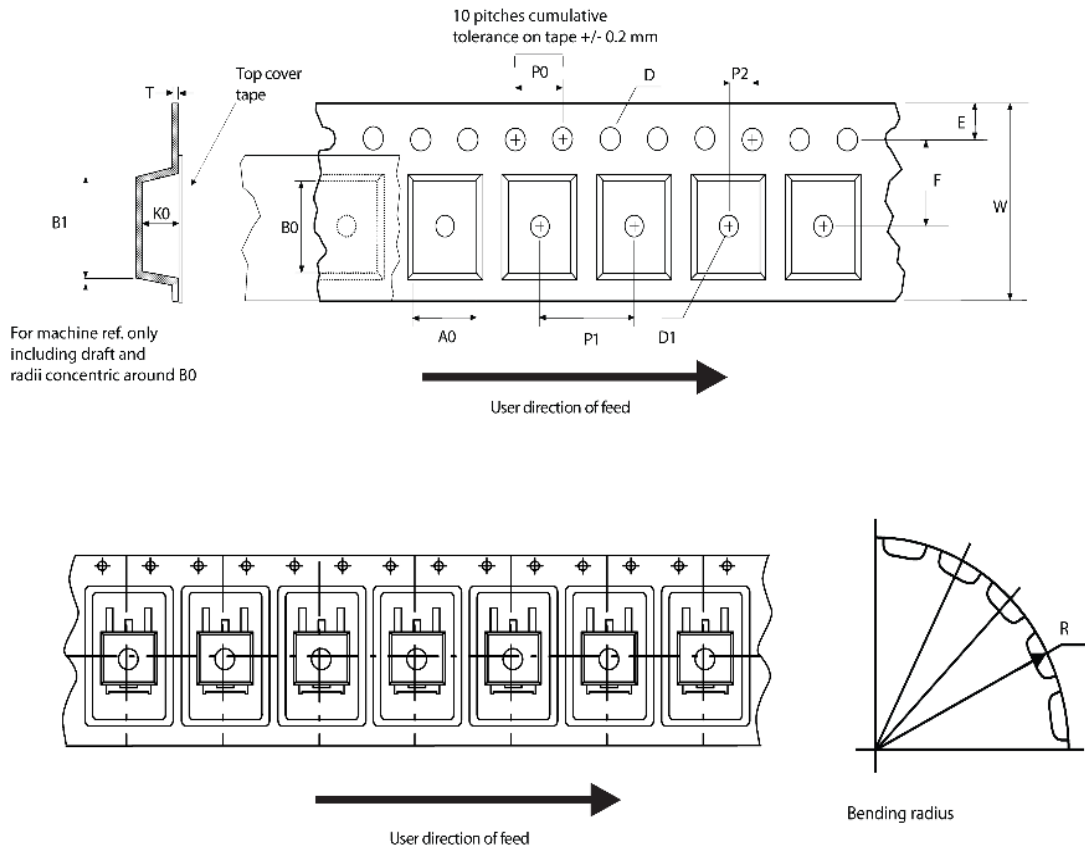
Dim.	mm		
	Min.	Typ.	Max.
A	4.40		4.60
A1	0.03		0.23
b	0.70		0.93
b2	1.14		1.70
c	0.45		0.60
c2	1.23		1.36
D	8.95		9.35
D1	7.50	7.75	8.00
D2	1.10	1.30	1.50
E	10.00		10.40
E1	8.70	8.90	9.10
E2	7.30	7.50	7.70
e		2.54	
e1	4.88		5.28
H	15.00		15.85
J1	2.49		2.69
L	2.29		2.79
L1	1.27		1.40
L2	1.30		1.75
R		0.40	
V2	0°		8°

**Figure 26. D<sup>2</sup>PAK (TO-263) recommended footprint (dimensions are in mm)**


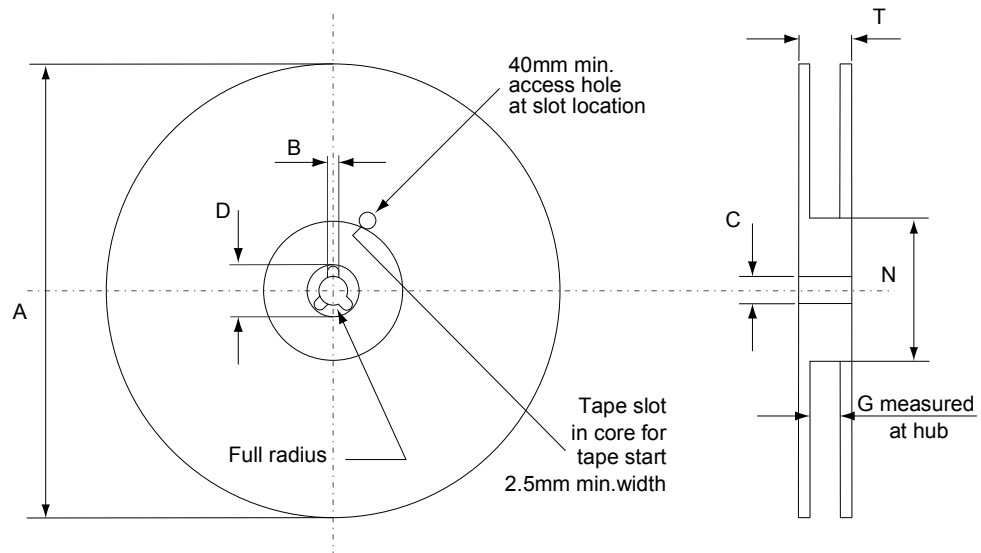
Footprint

## 4.2 D<sup>2</sup>PAK packing information

Figure 27. D<sup>2</sup>PAK tape outline



AM08852v1

**Figure 28. D<sup>2</sup>PAK reel outline**


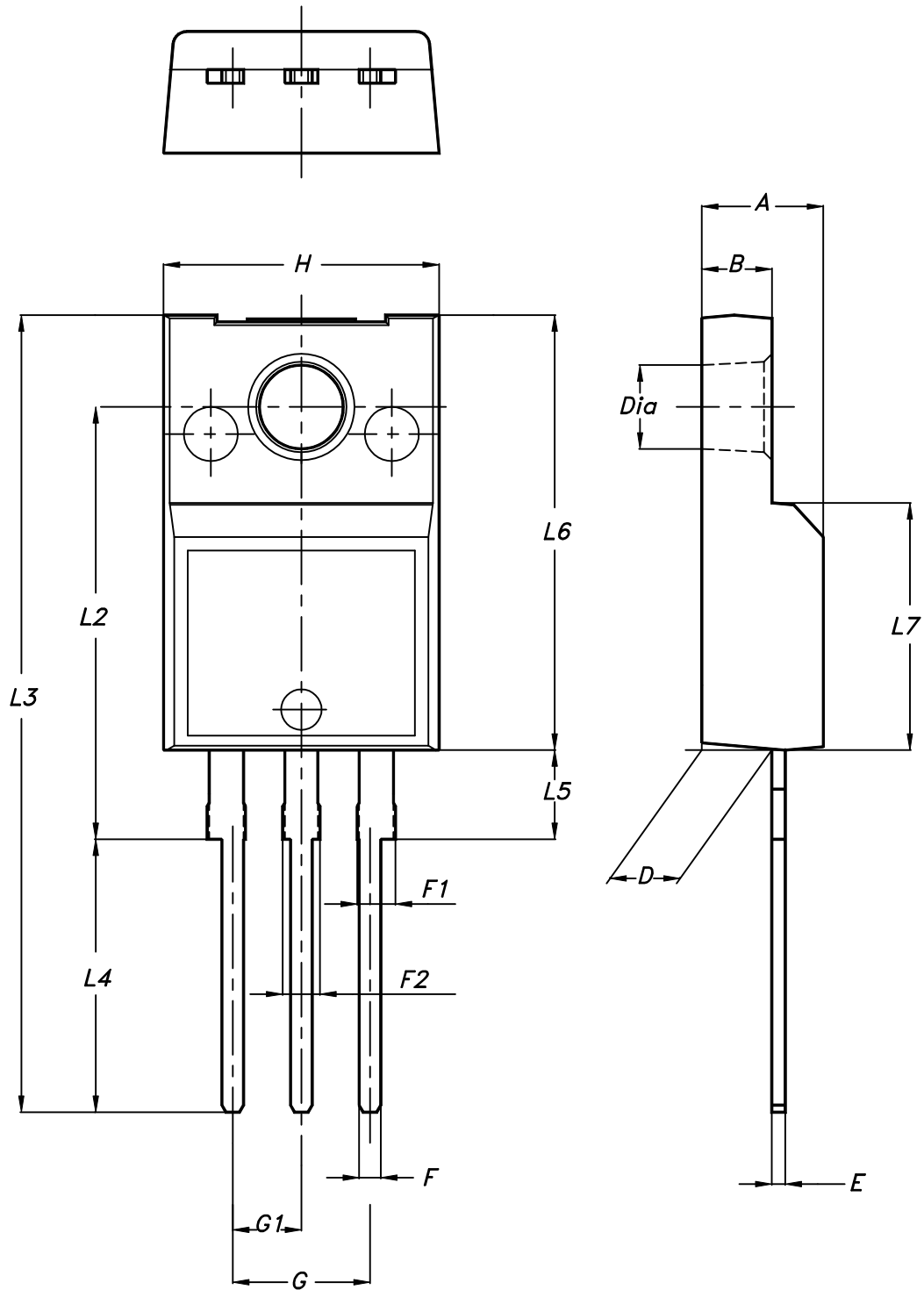
AM06038v1

**Table 9. D<sup>2</sup>PAK tape and reel mechanical data**

Tape			Reel			
Dim.	mm		Dim.	mm		
	Min.	Max.		Min.	Max.	
A0	10.5	10.7	A		330	
B0	15.7	15.9	B	1.5		
D	1.5	1.6	C	12.8	13.2	
D1	1.59	1.61	D	20.2		
E	1.65	1.85	G	24.4	26.4	
F	11.4	11.6	N	100		
K0	4.8	5.0	T		30.4	
P0	3.9	4.1	Base quantity Bulk quantity			
P1	11.9	12.1				1000
P2	1.9	2.1				1000
R	50					
T	0.25	0.35				
W	23.7	24.3				

### 4.3 TO-220FP package information

Figure 29. TO-220FP package outline



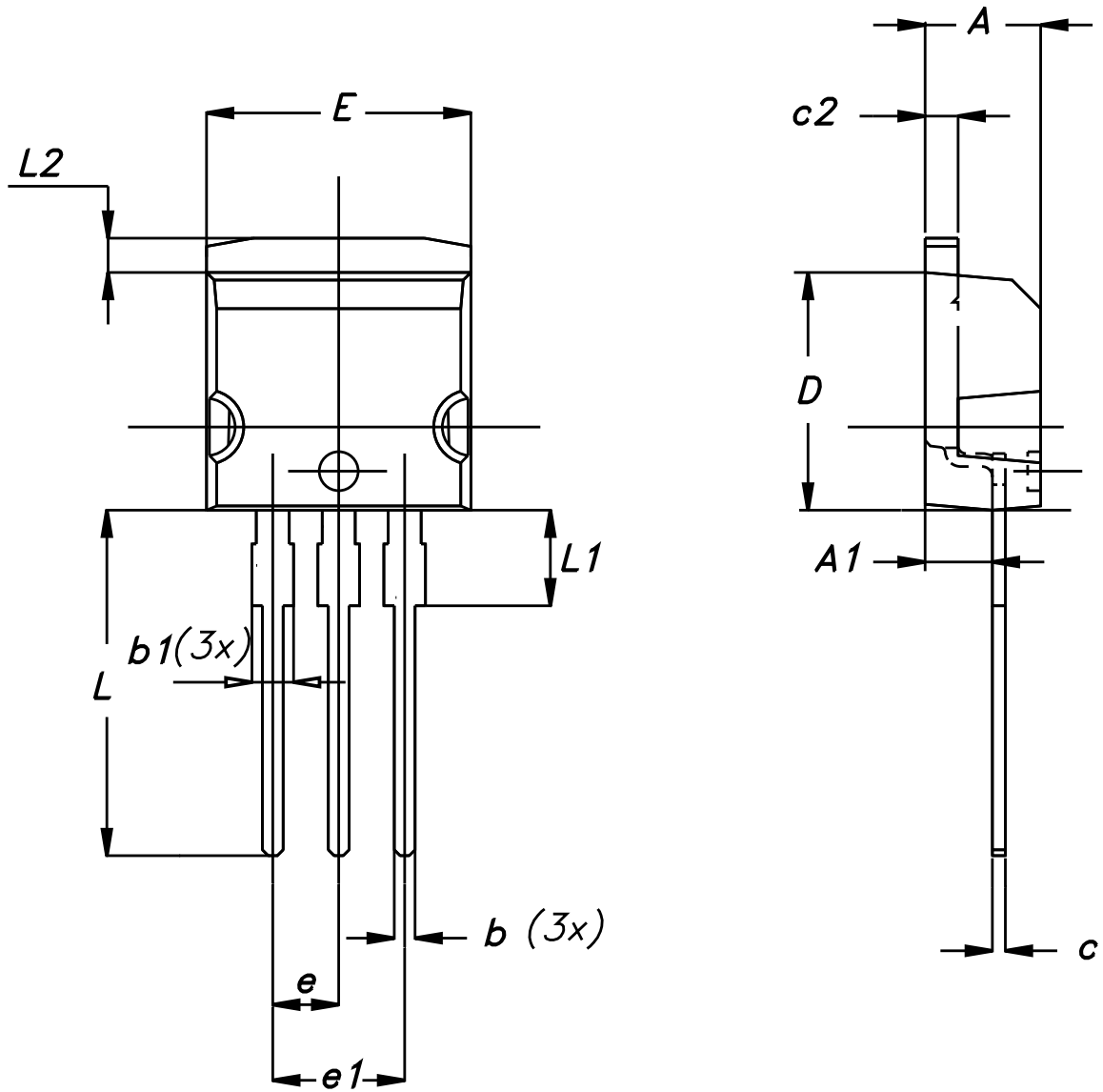
7012510\_Rev\_12\_B

**Table 10. TO-220FP package mechanical data**

Dim.	mm		
	Min.	Typ.	Max.
A	4.4		4.6
B	2.5		2.7
D	2.5		2.75
E	0.45		0.7
F	0.75		1
F1	1.15		1.70
F2	1.15		1.70
G	4.95		5.2
G1	2.4		2.7
H	10		10.4
L2		16	
L3	28.6		30.6
L4	9.8		10.6
L5	2.9		3.6
L6	15.9		16.4
L7	9		9.3
Dia	3		3.2

4.4 I<sup>2</sup>PAK package information

Figure 30. I<sup>2</sup>PAK package outline



0004982\_Rev\_H

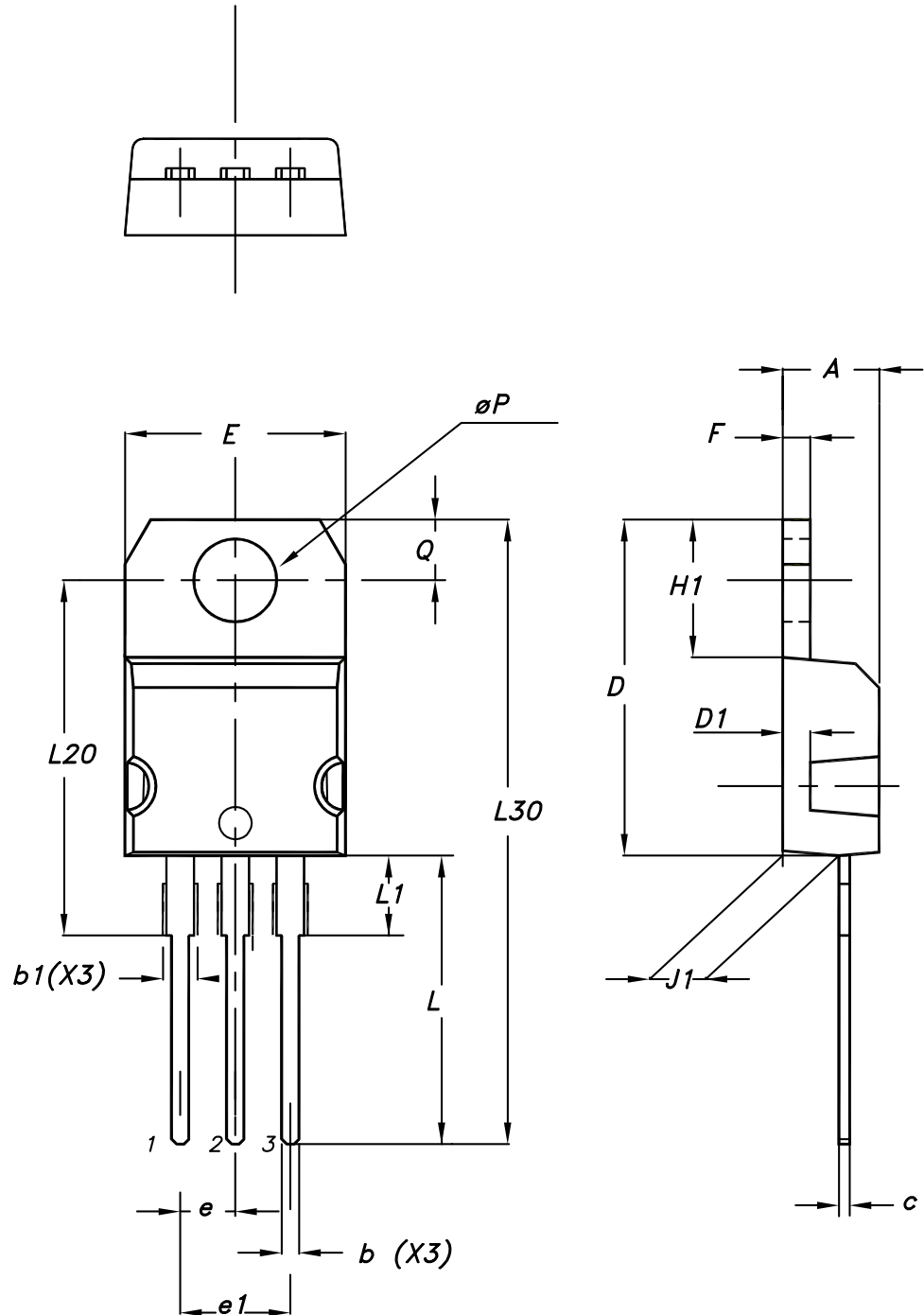


**Table 11. I<sup>2</sup>PAK package mechanical data**

Dim.	mm		
	Min.	Typ.	Max.
A	4.40	-	4.60
A1	2.40	-	2.72
b	0.61	-	0.88
b1	1.14	-	1.70
c	0.49	-	0.70
c2	1.23	-	1.32
D	8.95	-	9.35
e	2.40	-	2.70
e1	4.95	-	5.15
E	10	-	10.40
L	13	-	14
L1	3.50	-	3.93
L2	1.27	-	1.40

### 4.5 TO-220 type A package information

Figure 31. TO-220 type A package outline



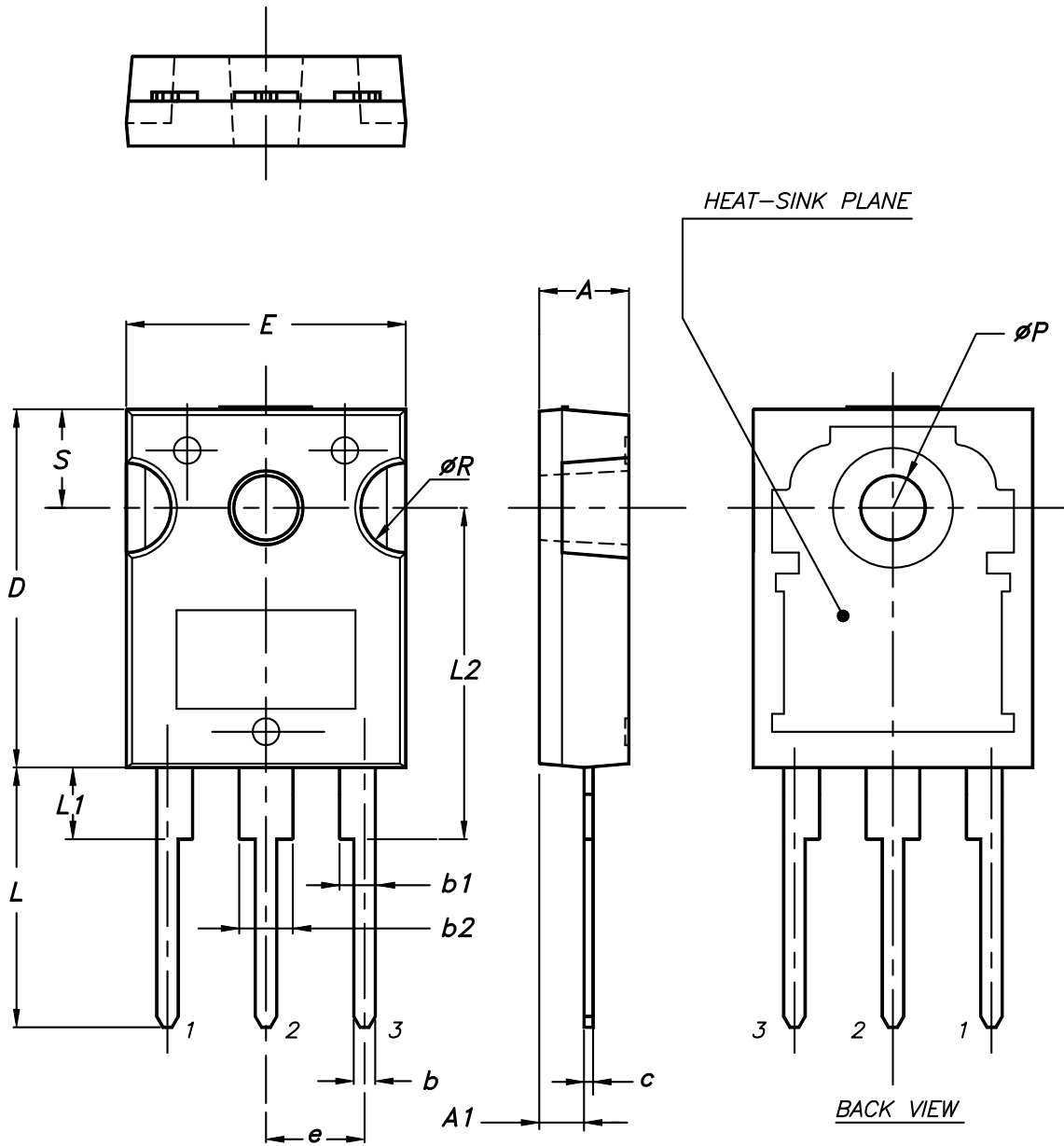
0015988\_typeA\_Rev\_22

**Table 12. TO-220 type A package mechanical data**

Dim.	mm		
	Min.	Typ.	Max.
A	4.40		4.60
b	0.61		0.88
b1	1.14		1.55
c	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10.00		10.40
e	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13.00		14.00
L1	3.50		3.93
L20		16.40	
L30		28.90	
øP	3.75		3.85
Q	2.65		2.95

4.6 TO-247 package information

Figure 32. TO-247 package outline



0075325\_9

**Table 13. TO-247 package mechanical data**

Dim.	mm		
	Min.	Typ.	Max.
A	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
c	0.40		0.80
D	19.85		20.15
E	15.45		15.75
e	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70

## 5 Ordering information

**Table 14. Order codes**

Order code	Marking	Package	Packing
STB42N65M5	42N65M5	D <sup>2</sup> PAK	Tape and reel
STF42N65M5		TO-220FP	Tube
STI42N65M5		I <sup>2</sup> PAK	
STP42N65M5		TO-220	
STW42N65M5		TO-247	

## Revision history

**Table 15. Document revision history**

Date	Version	Changes
16-Jan-2009	1	First release.
15-May-2009	2	Updated <i>figures 9, 10, 11</i> and <i>17</i>
12-Jun-2009	3	<i>Figure 15</i> has been updated
02-May-2019	4	Modified features and description on cover page. Updated <a href="#">Section 4 Package information</a> . Minor text changes.

## Contents

<b>1</b>	<b>Electrical ratings</b> .....	<b>2</b>
<b>2</b>	<b>Electrical characteristics</b> .....	<b>3</b>
<b>2.1</b>	Electrical characteristics (curves) .....	5
<b>3</b>	<b>Test circuits</b> .....	<b>8</b>
<b>4</b>	<b>Package information</b> .....	<b>9</b>
<b>4.1</b>	D <sup>2</sup> PAK (TO-263) type A2 package information .....	9
<b>4.2</b>	D <sup>2</sup> PAK packing information .....	11
<b>4.3</b>	TO-220FP package information .....	13
<b>4.4</b>	I <sup>2</sup> PAK package information .....	15
<b>4.5</b>	TO-220 type A package information .....	17
<b>4.6</b>	TO-247 package information .....	19
<b>5</b>	<b>Ordering information</b> .....	<b>22</b>
	<b>Revision history</b> .....	<b>23</b>





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